

We focus on power.

BROAD AREA LASER

GaAs Semiconductor Laser Diode

Single Emitter Structure



Revision 1.00





05.06.2014



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General Product Information

Product	Application
1064 nm Broad Area Laser	Medical
with Collimating Double Lens	Material Processing
Thermistor	



Absolute Maximum Ratings

	Symbol	Unit	min	typ	max
Storage Temperature	T_S	°C	-20		70
Operational Temperature at Case	T_{C}	°C	5		40
Forward Current	I _F	А			24
Reverse Voltage	V_R	V			2
Output Power	P _{opt}	W			18

non condensing
non condensing
Stress in excess of one of the Absolute Maximum
Ratings can cause permanent damage to the device.

Recommended Operational Conditions

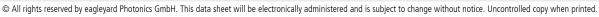
	Symbol	Unit	min	typ	max
Operational Temperature at Case	T _C	°C	15		30
Forward Current	I _F	Α			22
Output Power	P_{opt}	W			16

Measurement Conditions / Comments
non condensing

Characteristics at T_{LD} = 25 °C at Begin Of Life

Parameter	Symbol	Unit	min	typ	max
Center Wavelength	λ_{C}	nm	1049	1064	1079
Spectral Width (FWHM)	$\Delta\lambda$	nm		5	8
Temperature Coefficient of Wavelength	$d\lambda$ / dT	nm / K		0.4	
Output Power @ I _F = 22 A	P_{opt}	W	16		
Slope Efficiency	η_{d}	W/A	0.6	0.9	
Threshold Current	I_{th}	Α		1.0	2.5
Operational Current @ P _{opt} = 16 W	I _{op}	А		18	22
Voltage at Threshold	U_{th}	V	1.2		
Operational Voltage	U	V	1.4	1.6	2.2

Measurement Conditions / Comments				
$P_{opt} = 16 \text{ W}$				
total output measured with integrating sphere				
$I_F = I_{th}$ $P_{opt} = 16 \text{ W}$				
$P_{opt} = 16 \text{ W}$				







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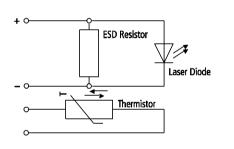
Characteristics at T _{amb} 25 °C at Begin Of Life	cont'd
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Parameter	Symbol	Unit	min	typ	max	
Differential Serial Resistance	R_{S}	mΩ	15	20	50	
Stripe Width	W_s	μm		200		
Cavity Length	L	μm		4000		
Divergence parallel	$\Theta_{ }$	0	1.0	1.5	2.0	
Divergence perpendicular	Θ_{\perp}	0	0.4	0.6	0.8	
Beam Width parallel	S	mm	2	3	4	
Beam Width perpendicular	F_{\perp}	mm	0.2	0.4	0.6	
Spectral Mode (longitudinal)			Multi Mode			
Polarization				TE		

Measurement Conditions / Comments	
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Casand Manage Edd Angela	
Second Moment Full Angle	
Second Moment Full Angle	
Polarization parallel to base plate	

ESD-Resistor

Parameter	Symbol	Unit	min	typ	max
Resistance	R _{ESD}	kΩ		1	



Thermistor (Standard NTC Type)

Parameter	Symbol	Unit	min	typ	max
Resistance	R	kΩ		10	
Beta Coefficient	β			4000	

 $T_c = 25^{\circ} C$





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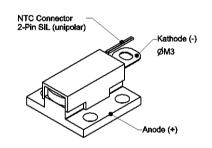
Package Dimensions

Parameter	Symbol	Unit	min	typ	max
Emission Plane	h _{EP}	mm	7.75	7.85	7.95
CDL Package Footprint	wxl	mm x mm		25 x 25	

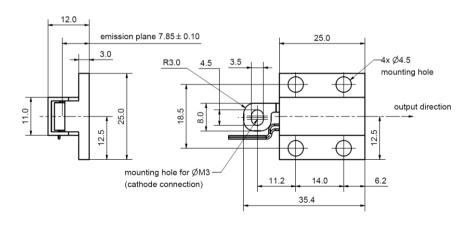
Measurement Conditions / Comments					

Package Pinout

Cathode (-)	Cable
Anode (+)	Housing
NTC	NTC Connector



Package Drawings



Z11-SPEC-CDL02-BAL-0000





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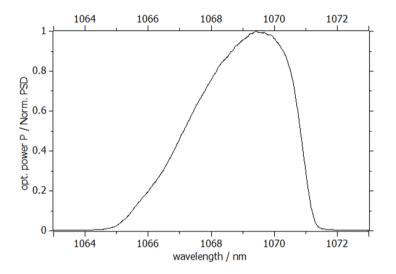






Typical Measurement Results

Emission Spectrum:



Performance figures, data and any illustrative material provided in this specification are typical and must be specifically confirmed in writing by eagleyard Photonics before they become applicable to any particular order or contract. In accordance with the eagleyard Photonics policy of continuous improvement specifications may change without notice.

Ordering Information:



800 Village Walk #316 Guilford, CT 06437 Ph: 203-401-8093

Email orders to: sales@xsoptix.com
Fax orders to: 800-878-7282

Unpacking, Installation and Laser Safety

Unpacking the laser diodes should only be done at electrostatic safe workstations (EPA). Though protection against electro static discharge (ESD) is implemented in the laser package, charges may occur at surfaces. Please store this product in its original package at a dry, clean place until final use. During device installation, ESD protection has to be maintained.

The BAL diode type is known to be sensitive against thermal stress. Operating at moderate temperatures on proper heat sinks will contribute to a long lifetime of the diode. The chip should be protected against moisture. A water vapor content below 5000 ppm is recommended for applications with high reliability requirements.

The laser emission from this diode is close to the invisible infrared region of the electromagnetic spectrum. Avoid direct and/or indirect exposure to the free running beam. Collimating the free running beam with optics as common in optical instruments will increase threat to the human eye.

Each laser diode will come with an individual test protocol verifying the parameters given in this document.

